

## REF34xx 低温漂、低功耗、小型串联电压基准

### 1 特性

- 初始精度： $\pm 0.05\%$  (最大值)
- 温度系数： $6\text{ppm}/^{\circ}\text{C}$  (最大值)
- 工作温度范围： $-40^{\circ}\text{C}$  至  $+125^{\circ}\text{C}$
- 输出电流： $\pm 10\text{mA}$
- 低静态电流： $95\text{ }\mu\text{A}$  (最大值)
- 超低零负载压降电压： $100\text{ mV}$  (最大值)
- 宽输入电压： $12\text{V}$
- 输出  $1/f$  噪声 ( $0.1\text{Hz}$  至  $10\text{Hz}$ )： $3.8\text{ }\mu\text{V}_{\text{pp}}/\text{V}$
- 出色的长期稳定性 ( $25\text{ppm}/1000$  小时)
- 多个小型 6 引脚 SOT-23 封装引脚排列：REF34xx 和 REF34xxT

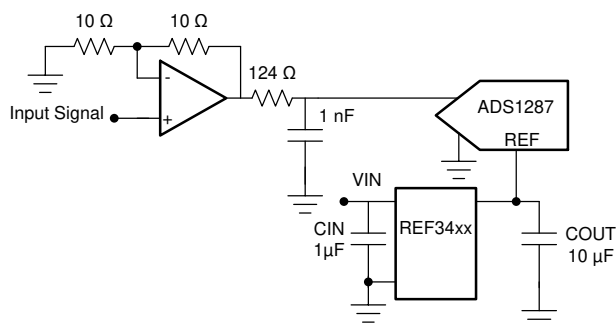
### 2 应用

- 数据采集系统
- 模拟 I/O 模块
- 现场发送器
- 实验室和现场仪表
- 伺服驱动器控制模块
- 直流电源、交流电源、电子负载

数据转换器基准电压建议

| 电压基准                | ADC 分辨率 <sup>(1)</sup> | DAC 分辨率 <sup>(1)</sup> |
|---------------------|------------------------|------------------------|
| TL431LI、TLV431      | 10 位                   | 8 位                    |
| LM4040、LM4050、REF30 | 12 位                   | 10 位                   |
| REF31、REF33、REF4132 | 14 位至 16 位             | 12 位                   |
| REF34、REF50         | 16 位至 18 位             | 14 位至 16 位             |
| REF70               | 18 位以上                 | 16 位以上                 |

(1) 有关特定的 ADC/DAC 建议，请参阅 [SNAA320](#)



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简化版原理图

### 3 说明

REF34xx 器件是低温漂 ( $6\text{ppm}/^{\circ}\text{C}$ )、低功耗、高精度 CMOS 电压基准，具有  $\pm 0.05\%$  初始精度、低运行电流以及小于  $95\text{ }\mu\text{A}$  的功耗。该器件还提供  $3.8\text{ }\mu\text{V}_{\text{pp}}/\text{V}$  的超低输出噪声，这使得它在用于噪声关键型系统中的高分辨率数据转换器时能够保持较高的信号完整性。REF34xx 采用小型 SOT-23 封装，具有更高的规格参数并且能够以引脚对引脚方式替代 MAX607x、ADR34xx 和 LT1790 (REF34xxT, 无 EN 引脚)。REF34xx 系列与大多数 ADC 和 DAC 兼容，如 [ADS1287](#)、[DAC8802](#) 和 [ADS1112](#)。

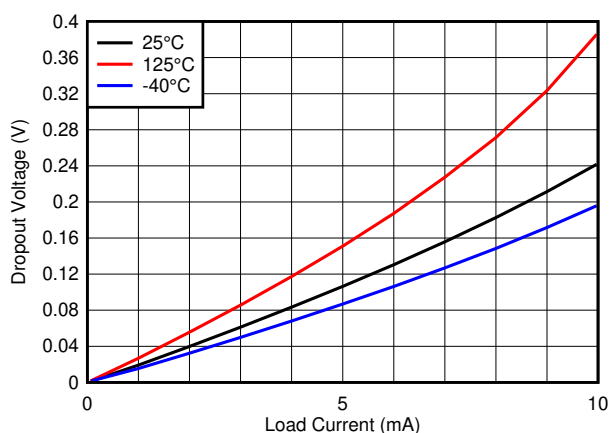
该器件的低输出电压迟滞和低长期输出电压漂移可进一步提高稳定性和系统可靠性。此外，器件的小尺寸和低运行电流 ( $95\text{ }\mu\text{A}$ ) 特性使其非常适合便携式和电池供电应用。

REF34xx 具有  $-40^{\circ}\text{C}$  至  $+125^{\circ}\text{C}$  的较宽额定温度范围。

器件信息

| 器件名称                | 封装 <sup>(1)</sup> | 封装尺寸 (标称值)      |
|---------------------|-------------------|-----------------|
| REF34xx<br>REF34xxT | SOT-23 (6)        | 2.90mm × 1.60mm |

(1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录



不同温度条件下压降与电流负载间的关系



## Table of Contents

|                                                  |    |                                                                      |    |
|--------------------------------------------------|----|----------------------------------------------------------------------|----|
| <b>1 特性</b> .....                                | 1  | 9.2 Functional Block Diagram.....                                    | 17 |
| <b>2 应用</b> .....                                | 1  | 9.3 Feature Description.....                                         | 17 |
| <b>3 说明</b> .....                                | 1  | 9.4 Device Functional Modes.....                                     | 18 |
| <b>4 Revision History</b> .....                  | 2  | <b>10 Application and Implementation</b> .....                       | 19 |
| <b>5 Device Comparison Table</b> .....           | 4  | 10.1 Application Information.....                                    | 19 |
| <b>6 Pin Configuration and Functions</b> .....   | 5  | 10.2 Typical Application: Basic Voltage Reference<br>Connection..... | 19 |
| <b>7 Specifications</b> .....                    | 6  | <b>11 Power Supply Recommendations</b> .....                         | 22 |
| 7.1 Absolute Maximum Ratings .....               | 6  | <b>12 Layout</b> .....                                               | 22 |
| 7.2 ESD Ratings .....                            | 6  | 12.1 Layout Guidelines.....                                          | 22 |
| 7.3 Recommended Operating Conditions .....       | 6  | 12.2 Layout Example.....                                             | 22 |
| 7.4 Thermal Information .....                    | 6  | <b>13 Device and Documentation Support</b> .....                     | 23 |
| 7.5 Electrical Characteristics .....             | 7  | 13.1 Documentation Support.....                                      | 23 |
| 7.6 Typical Characteristics.....                 | 9  | 13.2 接收文档更新通知.....                                                   | 23 |
| <b>8 Parameter Measurement Information</b> ..... | 13 | 13.3 支持资源.....                                                       | 23 |
| 8.1 Solder Heat Shift.....                       | 13 | 13.4 Trademarks.....                                                 | 23 |
| 8.2 Long-Term Stability.....                     | 14 | 13.5 Electrostatic Discharge Caution.....                            | 23 |
| 8.3 Thermal Hysteresis.....                      | 14 | 13.6 术语表.....                                                        | 23 |
| 8.4 Power Dissipation.....                       | 15 | <b>14 Mechanical, Packaging, and Orderable<br/>Information</b> ..... | 23 |
| 8.5 Noise Performance.....                       | 16 |                                                                      |    |
| <b>9 Detailed Description</b> .....              | 17 |                                                                      |    |
| 9.1 Overview.....                                | 17 |                                                                      |    |

## 4 Revision History

注：以前版本的页码可能与当前版本的页码不同

| <b>Changes from Revision E (April 2021) to Revision F (June 2021)</b>          | <b>Page</b> |
|--------------------------------------------------------------------------------|-------------|
| • 向“特性”部分添加了低压降行条目.....                                                        | 1           |
| • 在“器件信息”表中合并了器件型号.....                                                        | 1           |
| • Changed Thermal Information parameters to correctly reflect DBV package..... | 6           |
| • Added second cycle thermal hysteresis plot.....                              | 14          |
| • Linked product numbers in table to datasheets.....                           | 19          |

| <b>Changes from Revision D (February 2021) to Revision E (April 2021)</b>  | <b>Page</b> |
|----------------------------------------------------------------------------|-------------|
| • Removed the "Product Preview" note for the REF34xxT package options..... | 4           |

| <b>Changes from Revision C (January 2021) to Revision D (February 2021)</b> | <b>Page</b> |
|-----------------------------------------------------------------------------|-------------|
| • 更新了说明和图.....                                                              | 1           |
| • 将 ENABLE 更改为 EN.....                                                      | 1           |
| • Updated values.....                                                       | 13          |

| <b>Changes from Revision B (March 2018) to Revision C (February 2021)</b> | <b>Page</b> |
|---------------------------------------------------------------------------|-------------|
| • 添加了“器件信息”以添加 REF34xxT.....                                              | 1           |
| • 添加了指向“应用”的超链接.....                                                      | 1           |
| • 通篇将“V <sub>REF</sub> ”更改为“V <sub>OUT</sub> ”.....                       | 1           |
| • 更新了整个文档中的表格、图和交叉参考的编号格式.....                                            | 1           |
| • Added REF34xxT to "Device Comparison Table".....                        | 4           |
| • Added REF34xxT to "Pin Configuration and Functions".....                | 5           |

|                                                                         |    |
|-------------------------------------------------------------------------|----|
| • Fixed pinout numbering.....                                           | 5  |
| • Added Configuration Information to "Electrical Characteristics" ..... | 6  |
| • Changed ABS MAX IN MIN to "-0.3V".....                                | 6  |
| • Added REF34xxT to "Layout Guidelines" and "Layout Example".....       | 22 |

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#### Changes from Revision A (December 2017) to Revision B (March 2018)

**Page**

|                                                                                                                                                                                               |    |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----|
| • 添加了 2 个新 GPN : REF3440 和 REF3450.....                                                                                                                                                       | 1  |
| • 在 节 1 中将 “出色的长期稳定性 ( 30ppm/1000 小时 ) ” 更改为 “出色的长期稳定性 ( 25ppm/1000 小时 ) ” .....                                                                                                              | 1  |
| • Changed "...typical drift value for the REF34xx is 30 ppm from 0 to 1000 hours" to "...typical drift value for the REF34xx is 25 ppm from 0 to 1000 hours" and changed 图 8-3 in 节 8.2 ..... | 14 |
| • Changed "(as shown in Figure 26)" to " as shown in 图 9-1 in last paragraph of 节 10.2.2.2 .....                                                                                              | 20 |

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#### Changes from Revision \* (September 2017) to Revision A (December 2017)

**Page**

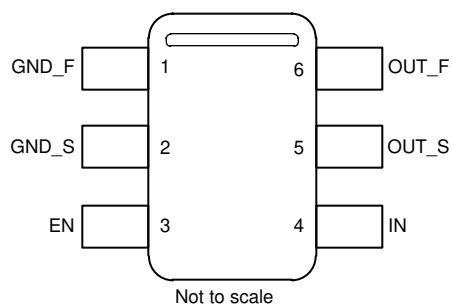
|                                                  |   |
|--------------------------------------------------|---|
| • 添加了 2 款全新输出电压选项器件 REF3430 和 REF3433 的产品发布..... | 1 |
|--------------------------------------------------|---|

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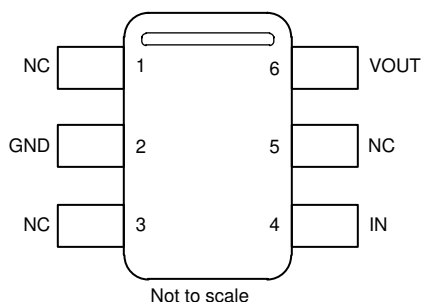
## 5 Device Comparison Table

| PRODUCT |          | V <sub>OUT</sub> |
|---------|----------|------------------|
| REF3425 | REF3425T | 2.5 V            |
| REF3430 | REF3430T | 3 V              |
| REF3433 | REF3433T | 3.3 V            |
| REF3440 | REF3440T | 4.096 V          |
| REF3450 | REF3450T | 5 V              |

## 6 Pin Configuration and Functions



**图 6-1. REF34xx  
DBV Package  
6-Pin SOT-23  
Top View**



**图 6-2. REF34xxT  
DBV Package  
6-Pin SOT-23  
Top View**

**表 6-1. Pin Functions**

| NAME  | PIN              |                   | TYPE   | DESCRIPTION                                                                                    |
|-------|------------------|-------------------|--------|------------------------------------------------------------------------------------------------|
|       | REF34xx<br>(DBV) | REF34xxT<br>(DBV) |        |                                                                                                |
| GND_F | 1                |                   | Ground | Ground force connection.                                                                       |
| GND_S | 2                |                   | Ground | Ground sense connection.                                                                       |
| GND   |                  | 2                 | Ground | Device ground.                                                                                 |
| EN    | 3                |                   | Input  | Enable connection. Enables or disables the device.                                             |
| IN    | 4                | 4                 | Power  | Input supply voltage connection.                                                               |
| OUT_S | 5                |                   | Input  | Reference voltage output sense connection.                                                     |
| OUT_F | 6                |                   | Output | Reference voltage output force connection.                                                     |
| VOUT  |                  | 6                 | Output | Reference voltage output connection.                                                           |
| NC    |                  | 1,3,5             | -      | Not connected. Pin can be left floating or connected to voltage within device operating range. |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                              |                  | MIN   | MAX      | UNIT |
|------------------------------|------------------|-------|----------|------|
| Input voltage                | IN               | – 0.3 | 13       | V    |
|                              | EN               | – 0.3 | IN + 0.3 | V    |
| Output voltage               | V <sub>OUT</sub> | – 0.3 | 5.5      | V    |
| Output short circuit current | I <sub>SC</sub>  |       | 20       | mA   |
| Operating temperature range  | T <sub>A</sub>   | – 55  | 150      | °C   |
| Storage temperature range    | T <sub>stg</sub> | – 65  | 170      | °C   |

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied. These are stress ratings only and functional operation of the device at these or any other conditions beyond those specified in the Electrical Characteristics Table is not implied.

### 7.2 ESD Ratings

|                    |                         |                                                                                | VALUE | UNIT |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2500 | V    |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1500 |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                |                       | MIN                                               | NOM | MAX | UNIT |
|----------------|-----------------------|---------------------------------------------------|-----|-----|------|
| IN             | Input Voltage         | V <sub>OUT</sub> + V <sub>DO</sub> <sup>(1)</sup> |     | 12  | V    |
| EN             | Enable Voltage        | 0                                                 |     | IN  | V    |
| I <sub>L</sub> | Output Current        | – 10                                              |     | 10  | mA   |
| T <sub>A</sub> | Operating Temperature | – 40                                              | 25  | 125 | °C   |

- (1) V<sub>DO</sub> = Dropout voltage

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | REF34T | REF34  | UNIT |
|-------------------------------|----------------------------------------------|--------|--------|------|
|                               |                                              | DBV    | DBV    |      |
|                               |                                              | 6 PINS | 6 PINS |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 122.6  | 122.6  | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 80.2   | 80.2   | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 42     | 42     | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 23.2   | 23.2   | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 41.9   | 41.9   | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | N/A    | N/A    | °C/W |

## 7.5 Electrical Characteristics

At  $V_{IN} = V_{OUT} + V_{DO}$ ,  $C_{OUT} = 10 \mu F$ ,  $C_{IN} = 0.1 \mu F$ ,  $I_L = 0 \text{ mA}$ , minimum and maximum specifications at  $T_A = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ; Typical specifications at  $T_A = 25^\circ\text{C}$  unless otherwise noted

| PARAMETER                            |                                                       | TEST CONDITION                                                                                                               |                                   | MIN                                | TYP   | MAX  | UNIT                 |
|--------------------------------------|-------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------|-----------------------------------|------------------------------------|-------|------|----------------------|
| ACCURACY AND DRIFT                   |                                                       |                                                                                                                              |                                   |                                    |       |      |                      |
|                                      | Output voltage accuracy                               | T <sub>A</sub> = 25°C                                                                                                        |                                   | - 0.05                             |       | 0.05 | %                    |
|                                      | Output voltage temperature coefficient <sup>(1)</sup> | - 40°C ≤ T <sub>A</sub> ≤ 125°C                                                                                              |                                   |                                    | 2.5   | 6    | ppm/°C               |
| LINE & LOAD REGULATION               |                                                       |                                                                                                                              |                                   |                                    |       |      |                      |
| Δ V <sub>O</sub> / Δ V <sub>IN</sub> | Line Regulation                                       | V <sub>IN</sub> = V <sub>OUT</sub> + V <sub>DO</sub> <sup>(2)</sup> to 12 V                                                  |                                   |                                    | 2     | 15   | ppm/V                |
| Δ V <sub>O</sub> / Δ I <sub>L</sub>  | Load Regulation                                       | I <sub>L</sub> = 0 mA to 10mA, V <sub>IN</sub> = V <sub>OUT</sub> + V <sub>DO</sub> <sup>(3)</sup>                           | Sourcing                          |                                    | 20    | 30   | ppm/mA               |
|                                      |                                                       |                                                                                                                              | Sinking, REF3425                  |                                    | 40    | 70   |                      |
|                                      |                                                       | I <sub>L</sub> = 0 mA to - 10mA, V <sub>IN</sub> = V <sub>OUT</sub> + V <sub>DO</sub> , T <sub>A</sub> = 25°C <sup>(3)</sup> | Sinking, REF3430                  |                                    | 43    | 75   |                      |
|                                      |                                                       |                                                                                                                              | Sinking, REF3433                  |                                    | 48    | 84   |                      |
|                                      |                                                       |                                                                                                                              | Sinking, REF3440                  |                                    | 60    | 98   |                      |
|                                      |                                                       |                                                                                                                              | Sinking, REF3450                  |                                    | 70    | 140  |                      |
| I <sub>SC</sub>                      | Short circuit current                                 | V <sub>OUT</sub> = 0 V at T <sub>A</sub> = 25°C                                                                              |                                   |                                    | 18    | 22   | mA                   |
| NOISE                                |                                                       |                                                                                                                              |                                   |                                    |       |      |                      |
| e <sub>np-p</sub>                    | Low frequency noise <sup>(4)</sup>                    | 0.1Hz ≤ f ≤ 10Hz                                                                                                             |                                   |                                    | 5     |      | μV <sub>p-p</sub> /V |
|                                      |                                                       | 0.1Hz ≤ f ≤ 10Hz (REF3440 and REF3450)                                                                                       |                                   |                                    | 3.8   |      |                      |
| e <sub>n</sub>                       | Integrated wide band noise                            | 10Hz ≤ f ≤ 10kHz                                                                                                             |                                   |                                    | 24    |      | μV <sub>rms</sub>    |
| e <sub>n</sub>                       | Output voltage noise density                          | f = 1kHz                                                                                                                     |                                   |                                    | 0.25  |      | ppm/ √ Hz            |
|                                      |                                                       | f = 1kHz (REF3440 and REF3450)                                                                                               |                                   |                                    | 0.2   |      |                      |
| LONG TERM STABILITY AND HYSTERESIS   |                                                       |                                                                                                                              |                                   |                                    |       |      |                      |
|                                      | Long-term stability <sup>(5)</sup>                    | DBV Package                                                                                                                  | 0 to 1000h at 35°C                |                                    | 25    |      | ppm                  |
|                                      |                                                       |                                                                                                                              | 1000h to 2000h at 35°C            |                                    | 10    |      |                      |
|                                      | Output voltage thermal hysteresis <sup>(6)</sup>      | DBV Package                                                                                                                  | 25°C, - 40°C, 125°C, 25°C Cycle 1 |                                    | 30    |      | ppm                  |
|                                      |                                                       |                                                                                                                              | 25°C, - 40°C, 125°C, 25°C Cycle 2 |                                    | 10    |      |                      |
| TURN-ON TIME                         |                                                       |                                                                                                                              |                                   |                                    |       |      |                      |
| t <sub>ON</sub>                      | Turn-on time                                          | 0.1% of output voltage settling, C <sub>L</sub> = 10 μF                                                                      |                                   |                                    | 2.5   |      | ms                   |
| CAPACITIVE LOAD                      |                                                       |                                                                                                                              |                                   |                                    |       |      |                      |
| C <sub>L</sub>                       | Stable output capacitor range                         | - 40°C ≤ T <sub>A</sub> ≤ 125°C                                                                                              |                                   |                                    | 0.1   | 10   | μF                   |
| OUTPUT VOLTAGE                       |                                                       |                                                                                                                              |                                   |                                    |       |      |                      |
| V <sub>OUT</sub>                     | Output voltage                                        | REF3425, REF3425T                                                                                                            |                                   |                                    | 2.5   |      | V                    |
|                                      |                                                       | REF3430, REF3430T                                                                                                            |                                   |                                    | 3.0   |      |                      |
|                                      |                                                       | REF3433, REF3433T                                                                                                            |                                   |                                    | 3.3   |      |                      |
|                                      |                                                       | REF3440, REF3440T                                                                                                            |                                   |                                    | 4.096 |      |                      |
|                                      |                                                       | REF3450, REF3450T                                                                                                            |                                   |                                    | 5.0   |      |                      |
| POWER SUPPLY                         |                                                       |                                                                                                                              |                                   |                                    |       |      |                      |
| V <sub>IN</sub>                      | Input voltage                                         |                                                                                                                              |                                   | V <sub>OUT</sub> + V <sub>DO</sub> |       | 12   | V                    |
| I <sub>L</sub>                       | Output current capacity                               | V <sub>IN</sub> = V <sub>OUT</sub> + V <sub>DO</sub> to 12 V                                                                 |                                   | - 10                               |       | 10   | mA                   |

## 7.5 Electrical Characteristics (continued)

At  $V_{IN} = V_{OUT} + V_{DO}$ ,  $C_{OUT} = 10\ \mu\text{F}$ ,  $C_{IN} = 0.1\ \mu\text{F}$ ,  $I_L = 0\ \text{mA}$ , minimum and maximum specifications at  $T_A = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ; Typical specifications at  $T_A = 25^\circ\text{C}$  unless otherwise noted

| PARAMETER |                            | TEST CONDITION                                  | MIN | TYP | MAX | UNIT          |
|-----------|----------------------------|-------------------------------------------------|-----|-----|-----|---------------|
| $I_Q$     | Quiescent current          | Active mode                                     |     | 72  | 95  | $\mu\text{A}$ |
|           |                            | Shutdown mode                                   |     | 2.5 | 3   |               |
| $V_{EN}$  | ENABLE pin voltage         | Voltage reference in active mode ( $EN = 1$ )   | 1.6 |     |     | V             |
|           |                            | Voltage reference in shutdown mode ( $EN = 0$ ) |     |     | 0.5 |               |
| $V_{DO}$  | Dropout voltage            | $I_L = 0\ \text{mA}$                            |     | 50  | 100 | mV            |
|           |                            | $I_L = 10\ \text{mA}$                           |     |     | 500 |               |
| $I_{EN}$  | ENABLE pin leakage current | $V_{EN} = V_{IN} = 12\text{V}$                  |     | 1   | 2   | $\mu\text{A}$ |

- (1) Temperature drift is specified according to the box method. See Low Temperature Drift section for more details.
- (2)  $V_{DO}$  for line regulation test is 50 mV.
- (3)  $V_{DO}$  for load regulation test is 500 mV.
- (4) The peak-to-peak noise measurement is explained in more detail in section Noise Performance.
- (5) Long-term stability measurement procedure is explained in more detail in section Long - Term Stability.
- (6) Thermal hysteresis measurement procedure is explained in more detail in section Thermal Hysteresis.

## 7.6 Typical Characteristics

at  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = 12\text{ V}$ ,  $I_L = 0\text{ mA}$ ,  $C_L = 10\text{ }\mu\text{F}$ ,  $C_{IN} = 0.1\text{ }\mu\text{F}$  (unless otherwise noted)

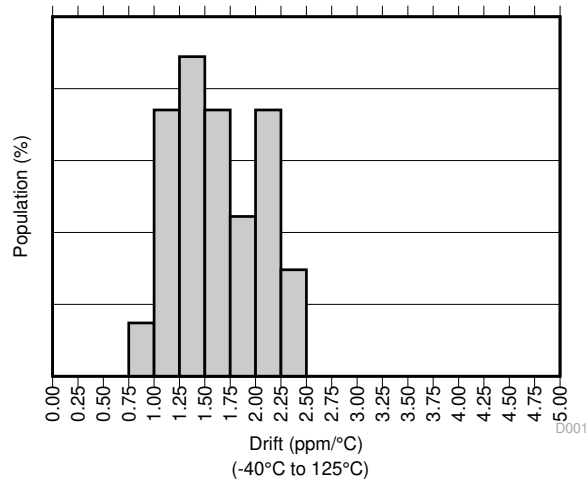


图 7-1. Temperature Drift

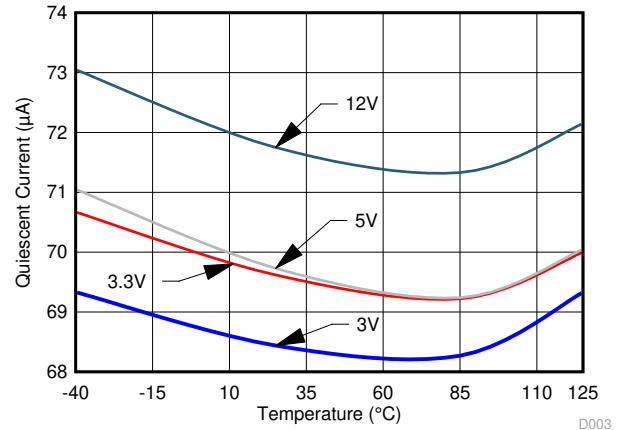


图 7-2.  $V_{IN}$  vs  $I_Q$  over Temperature

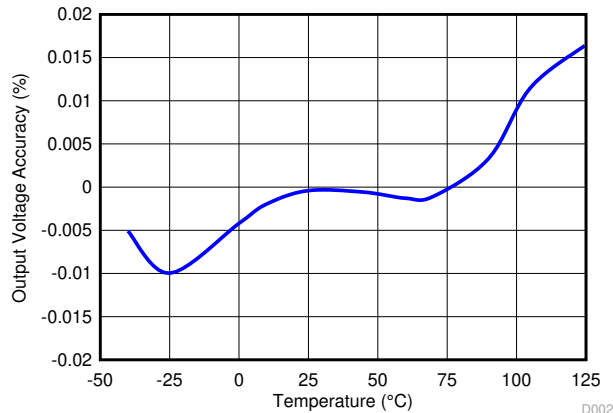


图 7-3. Output Voltage Accuracy vs Temperature

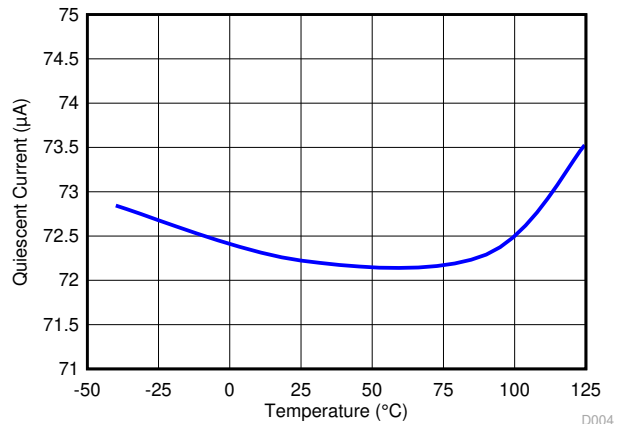


图 7-4. Quiescent Current vs Temperature

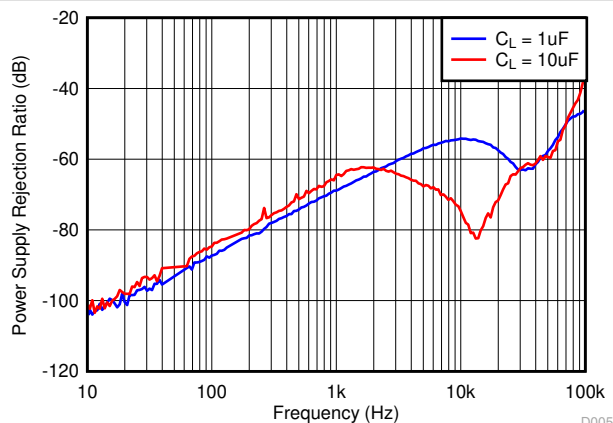


图 7-5. Power-Supply Rejection Ratio vs Frequency

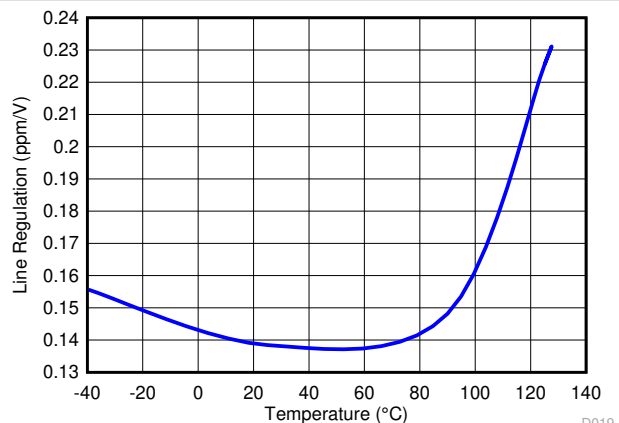


图 7-6. Line Regulation

## 7.6 Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = 12\text{ V}$ ,  $I_L = 0\text{ mA}$ ,  $C_L = 10\text{ }\mu\text{F}$ ,  $C_{IN} = 0.1\text{ }\mu\text{F}$  (unless otherwise noted)

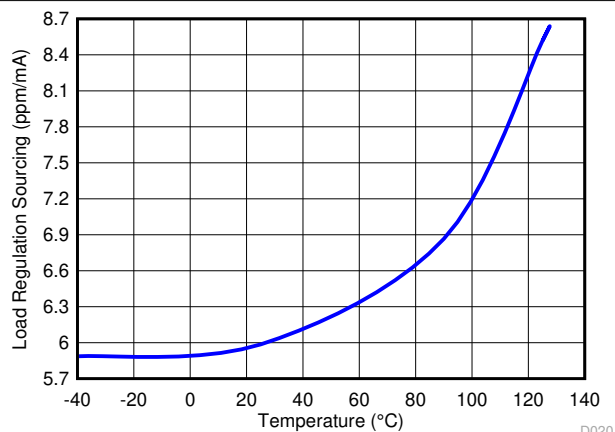


图 7-7. Load Regulation Sourcing

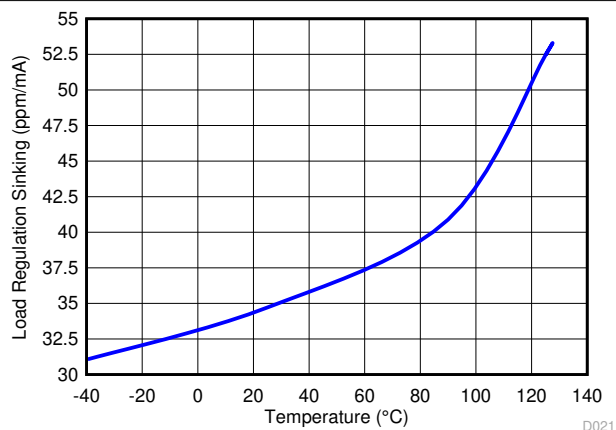


图 7-8. Load Regulation Sinking

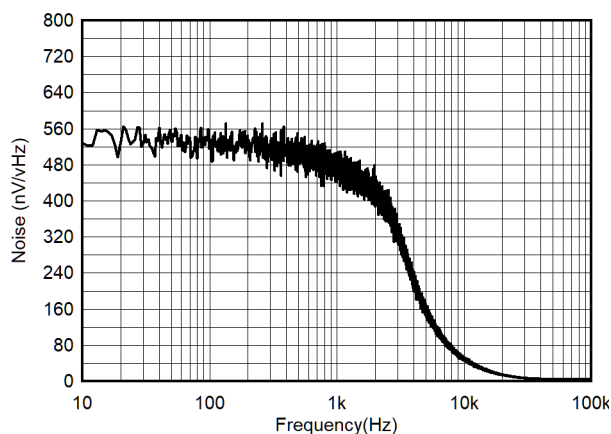


图 7-9. Noise Performance 10 Hz to 10 kHz

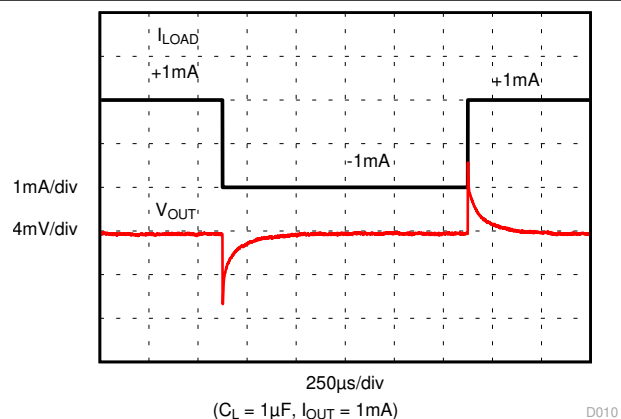


图 7-10. Load Transient

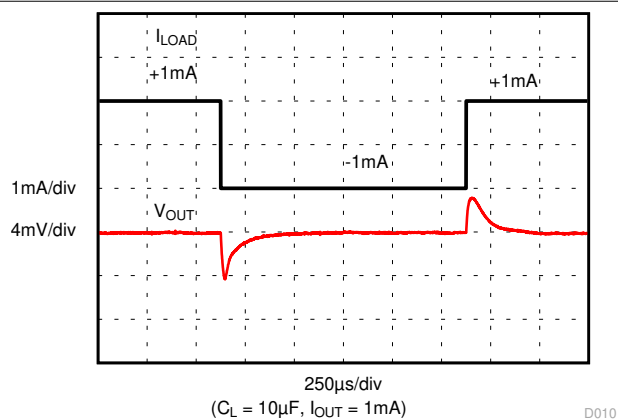


图 7-11. Load Transient

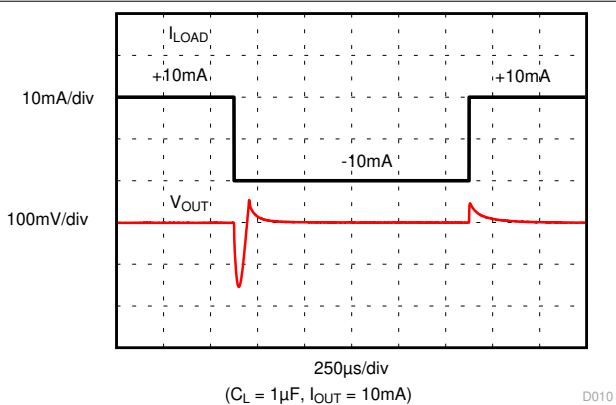
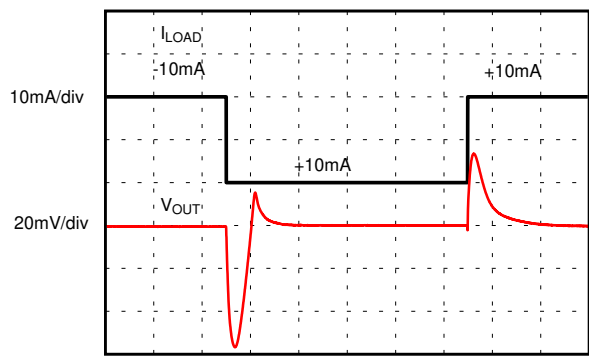


图 7-12. Load Transient

## 7.6 Typical Characteristics (continued)

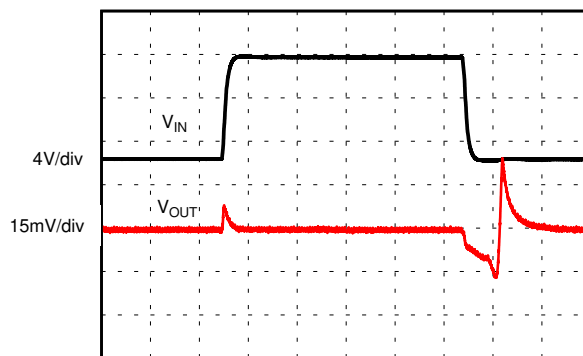
at  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = 12\text{ V}$ ,  $I_L = 0\text{ mA}$ ,  $C_L = 10\text{ }\mu\text{F}$ ,  $C_{IN} = 0.1\text{ }\mu\text{F}$  (unless otherwise noted)



250µs/div  
( $C_L = 10\text{ }\mu\text{F}$ ,  $I_{OUT} = 10\text{ mA}$ )

图 7-13. Load Transient

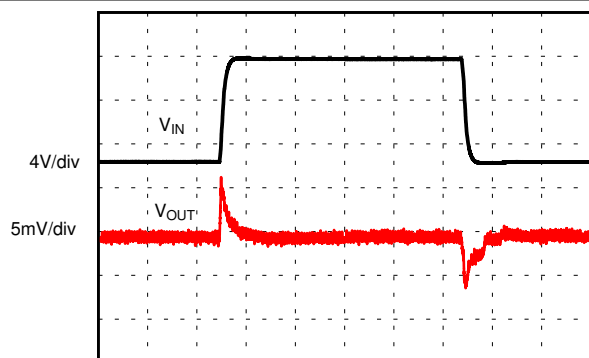
D010



250µs/div  
( $C_L = 1\text{ }\mu\text{F}$ )

图 7-14. Line Transient

D011



250µs/div  
( $C_L = 10\text{ }\mu\text{F}$ )

图 7-15. Line Transient

D011

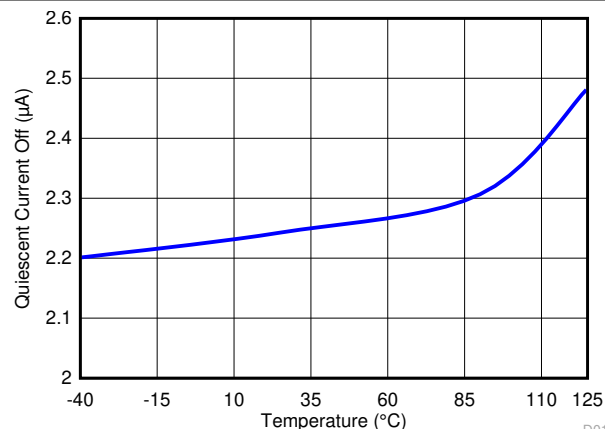


图 7-16. Quiescent Current Shutdown Mode

D013

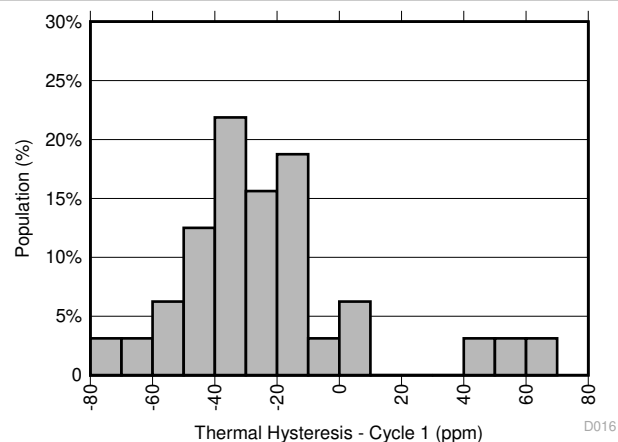


图 7-17. Thermal Hysteresis Distribution (Cycle 1)

D016

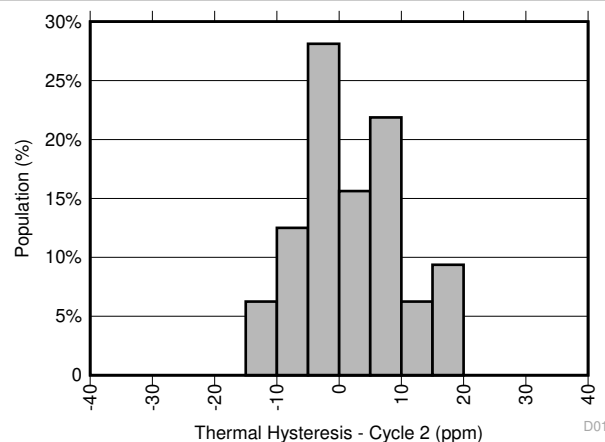
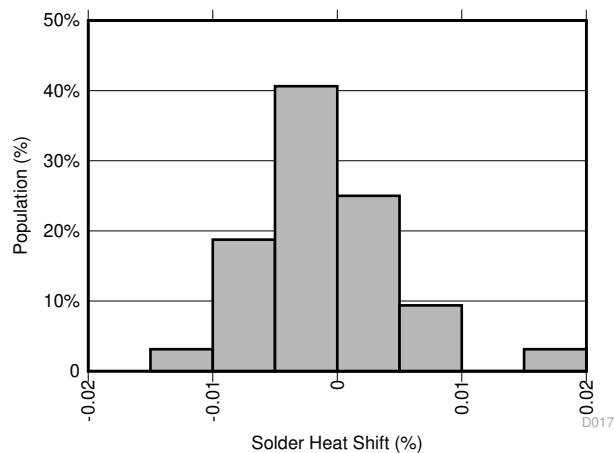


图 7-18. Thermal Hysteresis Distribution (Cycle 2)

D016

## 7.6 Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = 12\text{ V}$ ,  $I_L = 0\text{ mA}$ ,  $C_L = 10\text{ }\mu\text{F}$ ,  $C_{IN} = 0.1\text{ }\mu\text{F}$  (unless otherwise noted)



Refer to [Figure 8.1](#) for more information

图 7-19. Solder Heat Shift Distribution

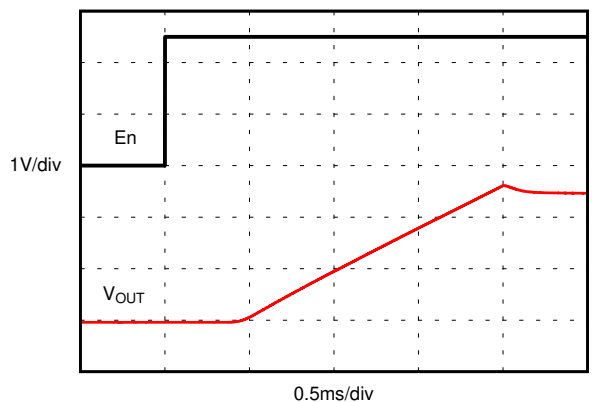


图 7-20. Turnon Time (Enable)

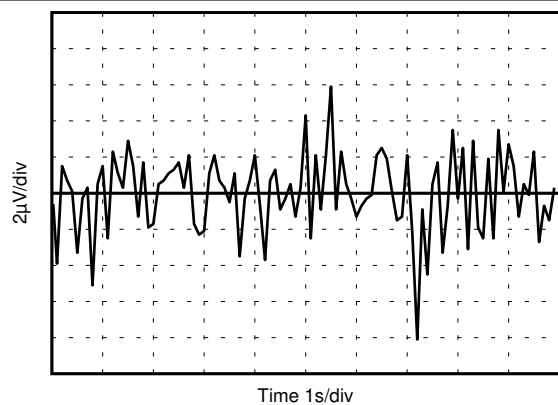


图 7-21. 0.1-Hz to 10-Hz Noise ( $V_{OUT}$ )

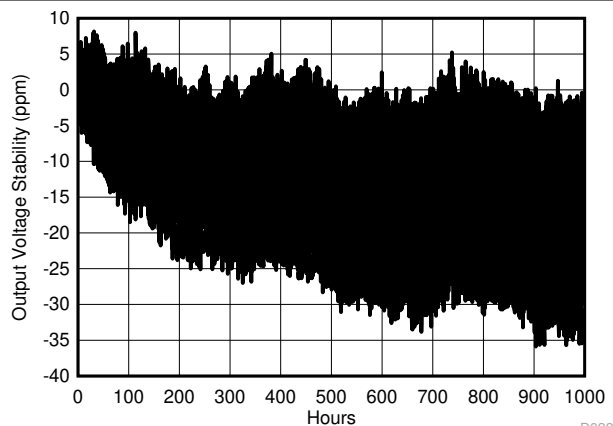


图 7-22. Long Term Stability - 1000 hours ( $V_{OUT}$ )

## 8 Parameter Measurement Information

### 8.1 Solder Heat Shift

The materials used in the manufacture of the REF34xx have differing coefficients of thermal expansion, resulting in stress on the device die when the part is heated. Mechanical and thermal stress on the device die can cause the output voltages to shift, degrading the initial accuracy specifications of the product. Reflow soldering is a common cause of this error.

In order to illustrate this effect, a total of 32 devices were soldered on 2 printed circuit boards [16 devices on each printed circuit board (PCB)] using lead-free solder paste and the paste manufacturer suggested reflow profile. The reflow profile is as shown in 图 8-1. The printed circuit board is comprised of FR4 material. The board thickness is 1.65 mm and the area is 114 mm × 152 mm.

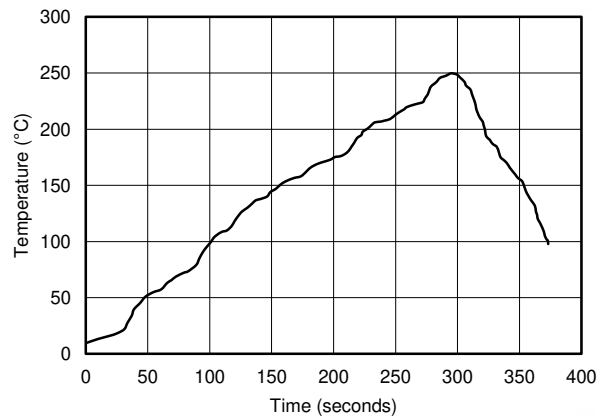


图 8-1. Reflow Profile

The reference output voltage is measured before and after the reflow process; the typical shift is displayed in 图 8-2. Although all tested units exhibit very low shifts (< 0.01%), higher shifts are also possible depending on the size, thickness, and material of the printed circuit board. An important note is that the histograms display the typical shift for exposure to a single reflow profile. Exposure to multiple reflows, as is common on PCBs with surface-mount components on both sides, causes additional shifts in the output bias voltage. If the PCB is exposed to multiple reflows, the device must be soldered in the last pass to minimize its exposure to thermal stress.

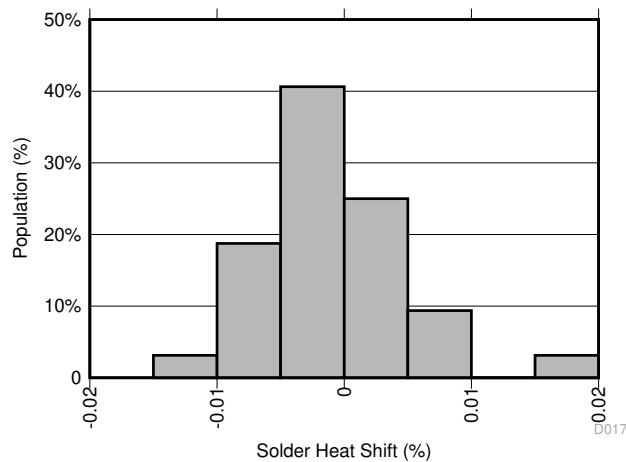


图 8-2. Solder Heat Shift Distribution,  $V_{OUT}$  (%)

## 8.2 Long-Term Stability

One of the key parameters of the REF34xx references is long-term stability. Typical characteristic expressed as: curves shows the typical drift value for the REF34xx is 25 ppm from 0 to 1000 hours. This parameter is characterized by measuring 32 units at regular intervals for a period of 1000 hours. It is important to understand that long-term stability is not ensured by design and that the output from the device may shift beyond the typical 25 ppm specification at any time. For systems that require highly stable output voltages over long periods of time, the designer should consider burning in the devices prior to use to minimize the amount of output drift exhibited by the reference over time.

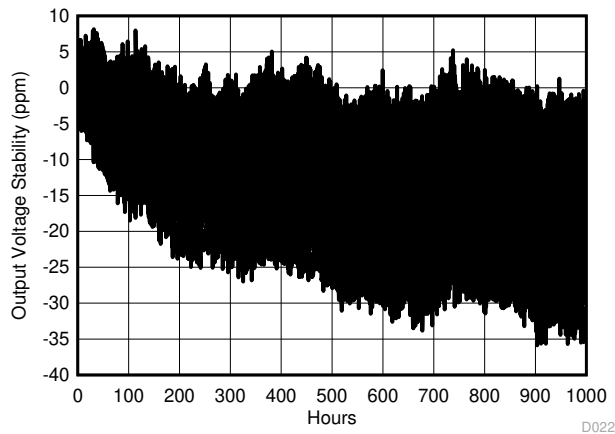


图 8-3. Long Term Stability - 1000 hours ( $V_{OUT}$ )

## 8.3 Thermal Hysteresis

Thermal hysteresis is measured with the REF34xx soldered to a PCB, similar to a real-world application. Thermal hysteresis for the device is defined as the change in output voltage after operating the device at 25°C, cycling the device through the specified temperature range, and returning to 25°C. The PCB was baked at 150°C for 30 minutes before thermal hysteresis was measured. Hysteresis can be expressed by 方程式 1:

$$V_{HYST} = \left( \frac{|V_{PRE} - V_{POST}|}{V_{NOM}} \right) \times 10^6 \text{ (ppm)} \quad (1)$$

where

- $V_{HYST}$  = thermal hysteresis (in units of ppm)
- $V_{NOM}$  = the specified output voltage
- $V_{PRE}$  = output voltage measured at 25°C pre-temperature cycling
- $V_{POST}$  = output voltage measured after the device has cycled from 25°C through the specified temperature range of -40°C to +125°C and returns to 25°C.

Typical thermal hysteresis distribution is as shown in 图 8-4 and 图 8-5.

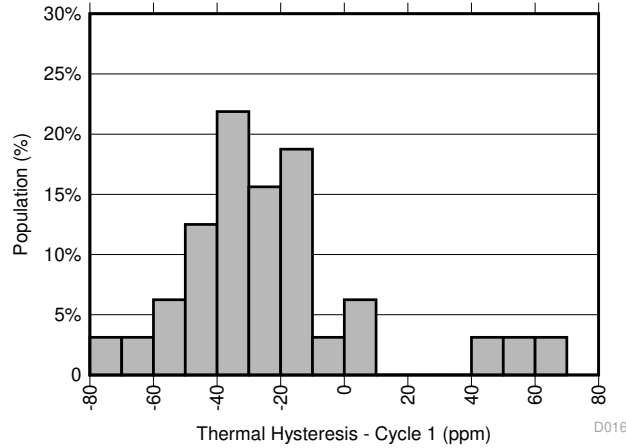


图 8-4. Thermal Hysteresis Distribution Cycle 1 (V<sub>OUT</sub>)

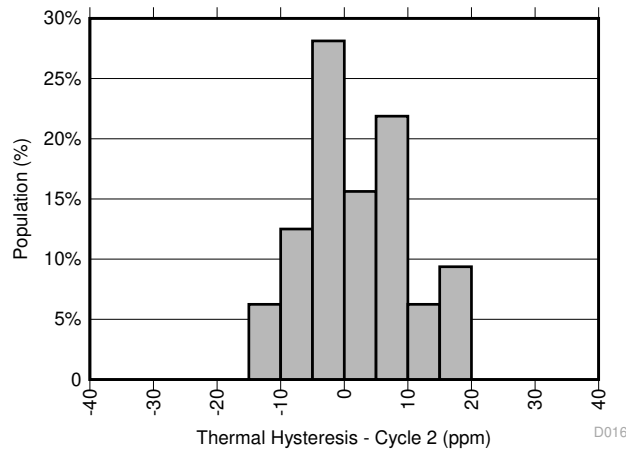


图 8-5. Thermal Hysteresis Distribution Cycle 2 (V<sub>OUT</sub>)

## 8.4 Power Dissipation

The REF34xx voltage references are capable of source and sink up to 10 mA of load current across the rated input voltage range. However, when used in applications subject to high ambient temperatures, the input voltage and load current must be carefully monitored to ensure that the device does not exceed its maximum power dissipation rating. The maximum power dissipation of the device can be calculated with 方程式 2:

$$T_J = T_A + P_D \times R_{\theta JA} \quad (2)$$

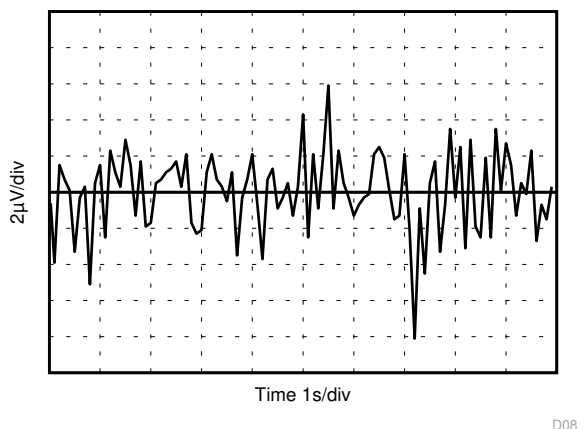
where

- $P_D$  is the device power dissipation
- $T_J$  is the device junction temperature
- $T_A$  is the ambient temperature
- $R_{\theta JA}$  is the package (junction-to-air) thermal resistance

Because of this relationship, acceptable load current in high temperature conditions may be less than the maximum current-sourcing capability of the device. In no case should the device be operated outside of its maximum power rating because doing so can result in premature failure or permanent damage to the device.

## 8.5 Noise Performance

Typical 0.1-Hz to 10-Hz voltage noise can be seen in [图 8-6](#). Device noise increases with output voltage and operating temperature. Additional filtering can be used to improve output noise levels, although care must be taken to ensure the output impedance does not degrade ac performance. Peak-to-peak noise measurement setup is shown in [图 8-6](#).



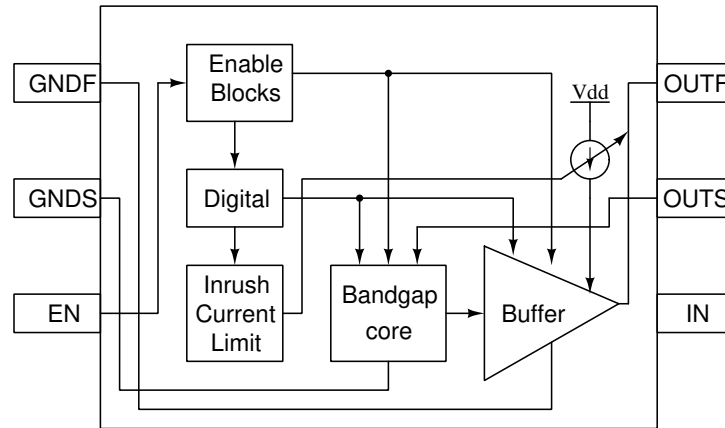
**图 8-6. 0.1-Hz to 10-Hz Noise ( $V_{OUT}$ )**

## 9 Detailed Description

### 9.1 Overview

The REF34xx is family of low-noise, precision bandgap voltage references that are specifically designed for excellent initial voltage accuracy and drift. The [Figure 9.2](#) is a simplified block diagram of the REF34xx showing basic band-gap topology.

### 9.2 Functional Block Diagram



### 9.3 Feature Description

#### 9.3.1 Supply Voltage

The REF34xx family of references features an extremely low dropout voltage. For loaded conditions, a typical dropout voltage versus load is shown on the front page. The REF34xx features a low quiescent current that is extremely stable over changes in both temperature and supply. The typical room temperature quiescent current is 72  $\mu$ A, and the maximum quiescent current over temperature is just 95  $\mu$ A. Supply voltages below the specified levels can cause the REF34xx to momentarily draw currents greater than the typical quiescent current. Use a power supply with a fast rising edge and low output impedance to easily prevent this issue.

#### 9.3.2 Low Temperature Drift

The REF34xx is designed for minimal drift error, which is defined as the change in output voltage over temperature. The drift is calculated using the box method, as described by [Equation 3](#). For this equation,  $V_{REF}$  is  $V_{OUT}$  which is the output voltage seen at the junction of OUT\_F and OUT\_S.

$$\text{Drift} = \left( \frac{V_{REF(MAX)} - V_{REF(MIN)}}{V_{REF(25^{\circ}\text{C})} \times \text{Temperature Range}} \right) \times 10^6 \quad (3)$$

#### 9.3.3 Load Current

The REF34xx family is specified to deliver a current load of  $\pm 10$  mA per output. The device temperature increases according to [Equation 4](#):

$$T_J = T_A + P_D \times R_{\theta JA} \quad (4)$$

where

- $T_J$  = junction temperature ( $^{\circ}\text{C}$ ),
- $T_A$  = ambient temperature ( $^{\circ}\text{C}$ ),
- $P_D$  = power dissipated (W), and
- $R_{\theta JA}$  = junction-to-ambient thermal resistance ( $^{\circ}\text{C/W}$ )

The REF34xx maximum junction temperature must not exceed the absolute maximum rating of 150 $^{\circ}\text{C}$ .

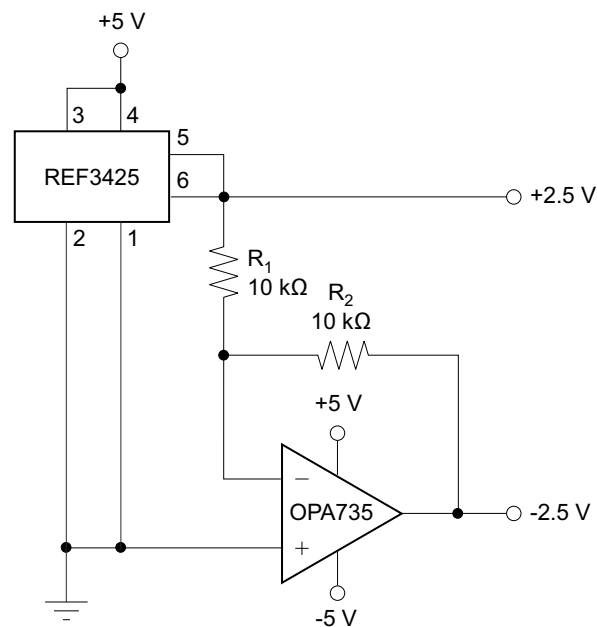
## 9.4 Device Functional Modes

### 9.4.1 EN Pin

When the EN pin of the REF34xx is pulled high, the device is in active mode. The device must be in active mode for normal operation. The REF34xx can be placed in a low-power mode by pulling the enable pin, EN, low. When in shutdown mode, the output of the device becomes high impedance and the quiescent current of the device reduces to 2  $\mu\text{A}$  in shutdown mode. The EN pin must not be pulled higher than VIN supply voltage. See the [节 7.5](#) for logic high and logic low voltage levels.

### 9.4.2 Negative Reference Voltage

For applications requiring a negative and positive reference voltage, the REF34xx and OPA735 can be used to provide a dual-supply reference from a 5-V supply. [图 9-1](#) shows the REF34xx used to provide a 2.5-V supply reference voltage. The low drift performance of the REF34xx complements the low offset voltage and zero drift of the OPA735 to provide an accurate solution for split-supply applications. Take care to match the temperature coefficients of R1 and R2.



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**图 9-1. REF34xx and OPA735 Create Positive and Negative Reference Voltages**

## 10 Application and Implementation

### Note

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

### 10.1 Application Information

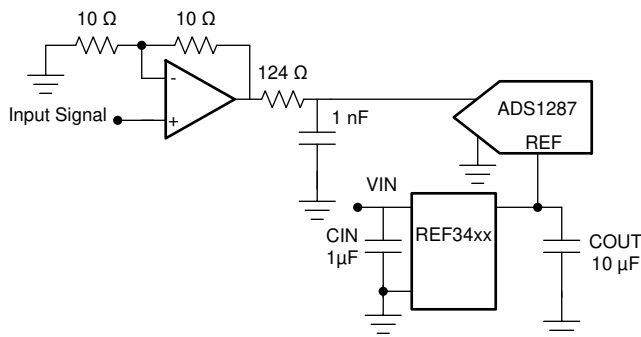
As this device has many applications and setups, there are many situations that this datasheet can not characterize in detail. Basic applications includes positive/negative voltage reference and data acquisition systems. The table below shows the typical application of REF34xx and its companion ADC/DAC.

**表 10-1. Typical Applications and Companion ADC/DAC**

| Applications                         | ADC/DAC                                               |
|--------------------------------------|-------------------------------------------------------|
| PLC - DCS                            | DAC8881, ADS8332, ADS8568, ADS8317, ADS8588S, ADS1287 |
| Display Test Equipment               | ADS8332                                               |
| Video Surveillance - Thermal Cameras | ADS7279                                               |
| Medical Blood Glucose Meter          | ADS1112                                               |

### 10.2 Typical Application: Basic Voltage Reference Connection

The circuit shown in 图 10-1 shows the basic configuration for the REF34xx references. Connect bypass capacitors according to the guidelines in 节 10.2.2.1.



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**图 10-1. Basic Reference Connection**

#### 10.2.1 Design Requirements

A detailed design procedure is described based on a design example. For this design example, use the parameters listed in 表 10-2 as the input parameters.

**表 10-2. Design Example Parameters**

| DESIGN PARAMETER         | VALUE      |
|--------------------------|------------|
| Input voltage $V_{IN}$   | 5 V        |
| Output voltage $V_{OUT}$ | 2.5 V      |
| REF34xx input capacitor  | 1 $\mu$ F  |
| REF34xx output capacitor | 10 $\mu$ F |

## 10.2.2 Detailed Design Procedure

### 10.2.2.1 Input and Output Capacitors

A 1- $\mu$ F to 10- $\mu$ F electrolytic or ceramic capacitor can be connected to the input to improve transient response in applications where the supply voltage may fluctuate. Connect an additional 0.1- $\mu$ F ceramic capacitor in parallel to reduce high frequency supply noise.

A ceramic capacitor of at least a 0.1  $\mu$ F must be connected to the output to improve stability and help filter out high frequency noise. An additional 1- $\mu$ F to 10- $\mu$ F electrolytic or ceramic capacitor can be added in parallel to improve transient performance in response to sudden changes in load current; however, keep in mind that doing so increases the turnon time of the device.

Best performance and stability is attained with low-ESR, low-inductance ceramic chip-type output capacitors (X5R, X7R, or similar). If using an electrolytic capacitor on the output, place a 0.1- $\mu$ F ceramic capacitor in parallel to reduce overall ESR on the output.

### 10.2.2.2 4-Wire Kelvin Connections

Current flowing through a PCB trace produces an IR voltage drop, and with longer traces, this drop can reach several millivolts or more, introducing a considerable error into the output voltage of the reference. A 1-inch long, 5-millimeter wide trace of 1-ounce copper has a resistance of approximately 100 m $\Omega$  at room temperature; at a load current of 10 mA, this can introduce a full millivolt of error. In an ideal board layout, the reference must be mounted as close as possible to the load to minimize the length of the output traces, and, therefore, the error introduced by voltage drop. However, in applications where this is not possible or convenient, force and sense connections (sometimes referred to as Kelvin sensing connections) are provided as a means of minimizing the IR drop and improving accuracy.

Kelvin connections work by providing a set of high impedance voltage-sensing lines to the output and ground nodes. Because very little current flows through these connections, the IR drop across their traces is negligible, and the output and ground voltage information can be obtained with minimum IR drop error.

It is always advantageous to use Kelvin connections whenever possible. However, in applications where the IR drop is negligible or an extra set of traces cannot be routed to the load, the force and sense pins for both V<sub>OUT</sub> and GND can simply be tied together, and the device can be used in the same fashion as a normal 3-terminal reference (as shown in [Figure 9-1](#)).

### 10.2.2.3 V<sub>IN</sub> Slew Rate Considerations

In applications with slow-rising input voltage signals, the reference exhibits overshoot or other transient anomalies that appear on the output. These phenomena also appear during shutdown as the internal circuitry loses power.

To avoid such conditions, ensure that the input voltage wave-form has both a rising and falling slew rate close to 6 V/ms.

### 10.2.2.4 Shutdown/Enable Feature

The REF34xx references can be switched to a low power shut-down mode when a voltage of 0.5 V or lower is input to the EN pin. Likewise, the reference becomes operational for EN voltages of 1.6 V or higher. During shutdown, the supply current drops to less than 2  $\mu$ A, useful in applications that are sensitive to power consumption.

If using the shutdown feature, ensure that the EN pin voltage does not fall between 0.5 V and 1.6 V because this causes a large increase in the supply current of the device and may keep the reference from starting up correctly. If not using the shutdown feature, however, the EN pin can simply be tied to the IN pin, and the reference remains operational continuously.

### 10.2.3 Application Curves

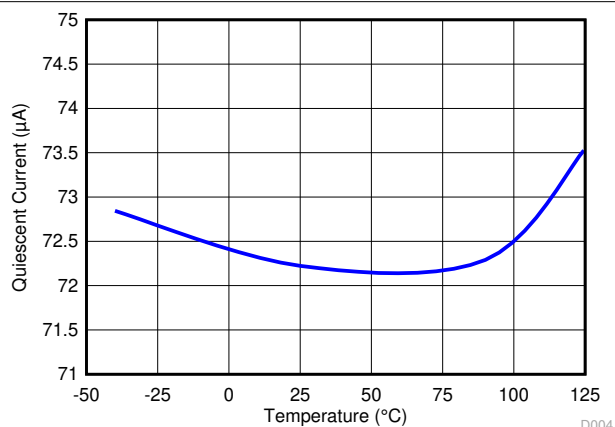


图 10-2. Quiescent Current vs Temperature

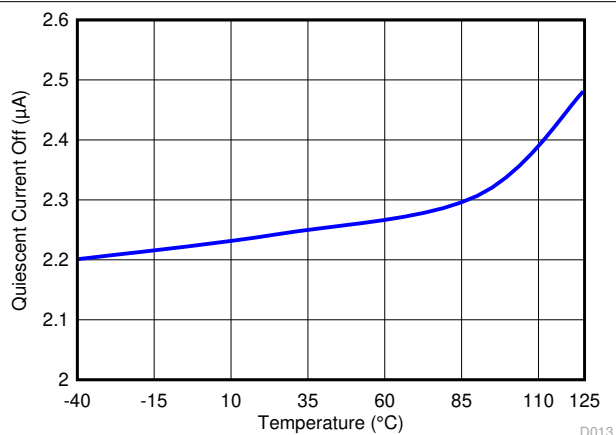


图 10-3. Quiescent Current Shutdown Mode

## 11 Power Supply Recommendations

The REF34xx family of references feature an extremely low-dropout voltage. These references can be operated with a supply of only 50 mV above the output voltage. TI recommends a supply bypass capacitor ranging between 0.1  $\mu$ F to 10  $\mu$ F.

## 12 Layout

### 12.1 Layout Guidelines

图 12-1 illustrates an example of a PCB layout for a data acquisition system using the REF34xx. Some key considerations are:

- Connect low-ESR, 0.1-  $\mu$ F ceramic bypass capacitors at IN, OUT\_F, VOUT of the REF34xx and REF34xxT.
- Decouple other active devices in the system per the device specifications.
- Using a solid ground plane helps distribute heat and reduces electromagnetic interference (EMI) noise pickup.
- Place the external components as close to the device as possible. This configuration prevents parasitic errors (such as the Seebeck effect) from occurring.
- Do not run sensitive analog traces in parallel with digital traces. Avoid crossing digital and analog traces if possible, and only make perpendicular crossings when absolutely necessary.

### 12.2 Layout Example

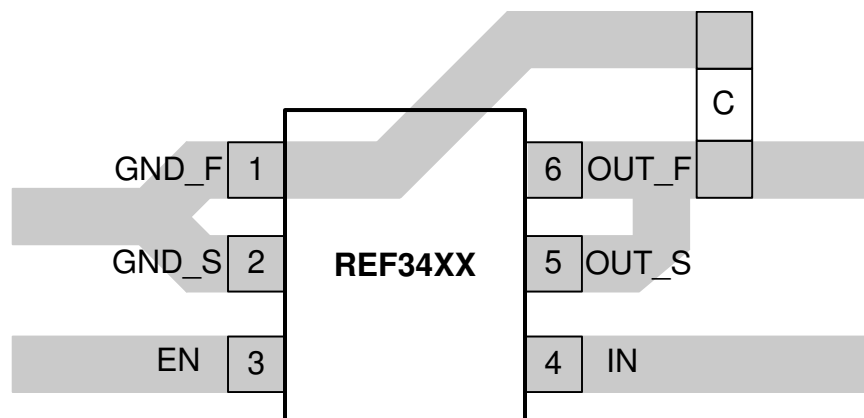


图 12-1. REF34xx Layout Example

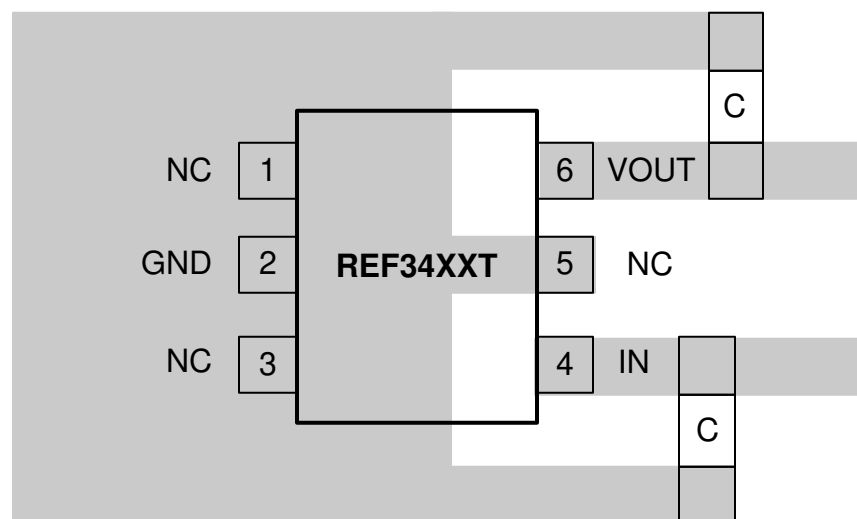


图 12-2. REF34xxT Layout Example

## 13 Device and Documentation Support

### 13.1 Documentation Support

#### 13.1.1 Related Documentation

For related documentation see the following:

- [INA21x Voltage Output, Low- or High-Side Measurement, Bidirectional, Zero-Drift Series, Current-Shunt Monitors](#)
- [Low-Drift Bidirectional Single-Supply Low-Side Current Sensing Reference Design](#)

### 13.2 接收文档更新通知

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链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的《[使用条款](#)》。

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### 13.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 13.6 术语表

**TI 术语表** 本术语表列出并解释了术语、首字母缩略词和定义。

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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## PACKAGING INFORMATION

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">REF3425IDBVR</a>  | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-250C-1 YEAR               | -40 to 125   | 19ED                |
| <a href="#">REF3425TIDBVR</a> | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-2-260C-1 YEAR               | -40 to 125   | 2EVC                |
| <a href="#">REF3430IDBVR</a>  | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 1H6D                |
| <a href="#">REF3430TIDBVR</a> | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-2-260C-1 YEAR               | -40 to 125   | 2EUC                |
| <a href="#">REF3433IDBVR</a>  | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 1H5D                |
| <a href="#">REF3433TIDBVR</a> | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-2-260C-1 YEAR               | -40 to 125   | 2ETC                |
| <a href="#">REF3440IDBVR</a>  | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 1MJD                |
| <a href="#">REF3440TIDBVR</a> | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-2-260C-1 YEAR               | -40 to 125   | 2ESC                |
| <a href="#">REF3450IDBVR</a>  | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | 1MKD                |
| <a href="#">REF3450TIDBVR</a> | Active        | Production           | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-2-260C-1 YEAR               | -40 to 125   | 2ERC                |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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**OTHER QUALIFIED VERSIONS OF REF3425, REF3430, REF3433, REF3440 :**

- Enhanced Product : [REF3425-EP](#), [REF3430-EP](#), [REF3433-EP](#), [REF3440-EP](#)

**NOTE: Qualified Version Definitions:**

- Enhanced Product - Supports Defense, Aerospace and Medical Applications

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| REF3425IDBVR  | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3425TIDBVR | SOT-23       | DBV             | 6    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3430IDBVR  | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3430TIDBVR | SOT-23       | DBV             | 6    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3433IDBVR  | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3433TIDBVR | SOT-23       | DBV             | 6    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3440IDBVR  | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3440TIDBVR | SOT-23       | DBV             | 6    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3450IDBVR  | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| REF3450TIDBVR | SOT-23       | DBV             | 6    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| REF3425IDBVR  | SOT-23       | DBV             | 6    | 3000 | 445.0       | 220.0      | 345.0       |
| REF3425TIDBVR | SOT-23       | DBV             | 6    | 3000 | 213.0       | 191.0      | 35.0        |
| REF3430IDBVR  | SOT-23       | DBV             | 6    | 3000 | 445.0       | 220.0      | 345.0       |
| REF3430TIDBVR | SOT-23       | DBV             | 6    | 3000 | 213.0       | 191.0      | 35.0        |
| REF3433IDBVR  | SOT-23       | DBV             | 6    | 3000 | 445.0       | 220.0      | 345.0       |
| REF3433TIDBVR | SOT-23       | DBV             | 6    | 3000 | 213.0       | 191.0      | 35.0        |
| REF3440IDBVR  | SOT-23       | DBV             | 6    | 3000 | 445.0       | 220.0      | 345.0       |
| REF3440TIDBVR | SOT-23       | DBV             | 6    | 3000 | 213.0       | 191.0      | 35.0        |
| REF3450IDBVR  | SOT-23       | DBV             | 6    | 3000 | 445.0       | 220.0      | 345.0       |
| REF3450TIDBVR | SOT-23       | DBV             | 6    | 3000 | 213.0       | 191.0      | 35.0        |



## SOT-23 - 1.45 mm max height

## SMALL OUTLINE TRANSISTOR



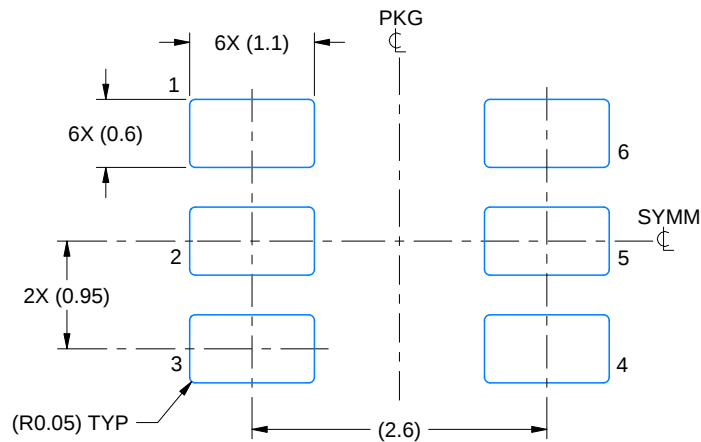
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.
4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
5. Reference JEDEC MO-178.

# EXAMPLE BOARD LAYOUT

DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214840/G 08/2024

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214840/G 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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